the chip's distribution chamber 605 spatially aligned to the cartridges's 600 bottom reservoir 604.

[0106] Upon transfer of a fluid sample from a suitable collection device retrieved fluid passes from the extraction chamber 601, through the draining duct 602, into the device's draining chamber. The segregation of bubbles occurs inside the draining chamber's top reservoir 603 by allowing the bubbles to rise upwards and accumulate as foam at the top of the reservoir 603 while the fluid accumulates at the reservoir base

[0107] The removal of solid impurities occurs in three stages during the process of sample transfer through the cartridge 600. In the first instance the largest impurities are removed as the sample passes from the extraction chamber 601 through the draining duct 602 into the draining chamber top reservoir 603, with the size and shape of the draining duct 602 determining the size of impurities being withheld. The second removal of impurities takes place at the intersection of distribution chamber 605 and channels 607 of the fluidic chip 606, with the dimensions and shape of the channel cross section determining the size of impurities being withheld. By selecting the width of the opening to be equal to that of the fluidic channel 607 and a combined depth of channel and bottom reservoir of between 0.5 mm and 1.5 mm, effective extraction and retention of solid impurities within the top reservoir 603 can be routinely achieved. The third and most detailed removal of fine impurities is achieved through the reagent pads 608, with the pads porosity determining the size of impurities being withheld.

[0108] The narrow profile of the bottom reservoir 604 facilitates conditioning of the fluid sample, and thus quick and even filling of the distribution chamber 605 of the fluidic chip 606. The cross-sectional diagram B shows the distribution chamber 605 is shallow in the 3<sup>rd</sup> direction but elongated in the second direction along the top of the channels 42 for effective spreading into the channels 42.

[0109] In the embodiment of FIG. 6b, the sequence of sample fluid flow in the first, second, and third directions still applies. However, upon moving in the third direction, it continues in the third direction along the channels, whereas in the FIG. 6a embodiment, it changes back to the first direction to flow along the channels.

[0110] Quick spreading (in about 1 to 2 sec) of the fluid across all of the channel inlet ports 41 can subsequently results in timely, uniform filling of all of the fluidic channels 607 of the chip 600. The dimensions of the bottom reservoir 604 are a determinant of the overall effectiveness of the conditioning process and of the uniformity with which the filling of the fluidic channels subsequently occurs. By selecting the width of the bottom reservoir 604 to be substantially equal to that of the fluidic chip 606, the height to be substantially equal to the length of the sample inlet ports 41 of the fluidic chip 600 and the depth to be between about 0.25 mm and about 2 mm, uniform capillary filling of the fluidic chip's 606 channels by conditioned, retrieved fluid samples with viscosities ranging between 1 and 20 cp can be routinely achieved.

[0111] Referring to FIGS. 7*a* and 7*b*, in various embodiments, fluidic chips 26 may be fabricated (FIG. 7*a*) by laminating multiple planar layers comprising a support layer 74, a layer 73 with through-cut channel and well features, and an optically clear top layer 71. Reagent, sensor and absorbent pads 72 may be introduced into the channels 42 at appropriate locations, and in a discontinuous, non-contiguous manner,

prior to lamination of the top layer 71, and may be fixed in place during the lamination process. To provide fluid flow into the channels 42, entry ports may be formed in each laminated structure either at the edges or through the support layer 74 or top layer 71. While there are only five channels illustrated, the fluidic chip may incorporate a different number of channels. In various embodiments, fluidic chips 26 may be fabricated (FIG. 7b) by injection moulding a support plate 75 with embedded channel structures. Reagent, sensor and absorbent pads 72 may be introduced into the channels 42 at appropriate location's, and in a discontinuous, non-contiguous manner, prior to lamination of the top layer 71, and may be fixed in place during the lamination process.

[0112] Referring to FIG. 8*a*, in various embodiments, reagent, sensor and absorbent pads 802 are integrated into the channels 801 of a fluidic chip 800 as discretely spaced entities at appropriate locations in a discontinuous, non-contiguous manner, through suitable assembly techniques.

[0113] Referring to FIG. 8b, a fluidic chip 810 has integrated pads, whereby the reagent, sensor and absorbent pads 812 are held in place in discrete and separate positions at appropriate locations in a discontinuous, non-contiguous manner, via the surrounding walls of the fluidic channel 811.

[0114] Referring to FIG. 8c, in a fluidic chip 820 the reagent, sensor and absorbent pads 822 are held in place in discrete and separate positions at appropriate locations in a discontinuous, non-contiguous manner, via recesses, which form part of the channel structure 821 and which accommodate part of the pad structure 822. Said recesses may be part of the horizontal or vertical or horizontal and vertical channel walls 821. The recesses have typical dimensions in the range of about 0.1 mm to about 1 mm in width, about 0.05 mm to about 1.00 mm in height and about 1 mm to about 50 mm in length.

[0115] Referring to FIG. 8d, a fluidic chip 830 has reagent, sensor and absorbent pads 832 held in place in discrete and separate positions at appropriate locations in a discontinuous, non-contiguous manner, via a continuous adhesive coating 833, which forms part of the base of the channel structure 831. [0116] Referring to FIG. 8e, in a fluidic chip 840 the reagent, sensor and absorbent pads 842 are held in place in discrete and separate positions at appropriate locations in a discontinuous, non-contiguous manner, inside recesses 843, which have an adhesive coating at their base, and which form part of the channel structure 841. The recesses may be formed by means of a nonporous mask 844 directly applied onto the adhesive coating, with spaces provided in this masks with typical dimensions in the range of about 0.1 mm to about 1 mm in width, about 0.05 mm to about 1.00 mm in height and about 1 mm to about 50 mm in length.

[0117] Referring to FIG. 8*f*, in a fluidic chip 850 reagent, sensor and absorbent pads 852 are held in place in discrete and separate positions at appropriate locations in a discontinuous, non-contiguous manner, via single or multiple discontinuous areas of adhesive coatings 853, which form part of the channel structure 851. In various embodiments, said coatings have typical dimensions in the range of about 0.25 mm to about 5 mm in width and about 0.5 mm to about 25 mm in length.

[0118] Referring to FIG. 8g, in a fluidic chip 860 reagent, sensor and absorbent pads 862 are held in place in discrete and separate positions at appropriate locations in a discon-